



SANYO Semiconductors

DATA SHEET

VEC2408 — N-Channel Silicon MOSFET

General-Purpose Switching Device Applications

Features

- The best suited for load switching applications.
- Low ON-resistance.
- Composite type facilitating high-density mounting.
- 1.8V drive.
- Mounting high 0.75mm.

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V _{DSS}		20	V
Gate-to-Source Voltage	V _{GSS}		±12	V
Drain Current (DC)	I _D		3.5	A
Drain Current (Pulse)	I _{DP}	PW≤10μs, duty cycle≤1%	14	A
Allowable Power Dissipation	P _D	Mounted on a ceramic board (900mm ² ×0.8mm)1unit	0.9	W
Total Dissipation	P _T	Mounted on a ceramic board (900mm ² ×0.8mm)	1.0	W
Channel Temperature	T _{ch}		150	°C
Storage Temperature	T _{stg}		-55 to +150	°C

Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Drain-to-Source Breakdown Voltage	V(BR)DSS	I _D =1mA, V _{GS} =0V	20			V
Zero-Gate Voltage Drain Current	I _{DSS}	V _{DS} =20V, V _{GS} =0V			1	μA
Gate-to-Source Leakage Current	I _{GSS}	V _{GS} =±8V, V _{DS} =0V			±10	μA
Cutoff Voltage	V _{GS(off)}	V _{DS} =10V, I _D =1mA	0.4		1.3	V
Forward Transfer Admittance	y _{fs}	V _{DS} =10V, I _D =1.5A	2.4	4		S
Static Drain-to-Source On-State Resistance	R _{DS(on)1}	I _D =2A, V _{GS} =4V	37	47	60	mΩ
	R _{DS(on)2}	I _D =1A, V _{GS} =2.5V	42	61	85	mΩ
	R _{DS(on)3}	I _D =0.5A, V _{GS} =1.8V	47	79	118	mΩ
	R _{DS(on)4}	I _D =0.1A, V _{GS} =1.4V	72	167	540	mΩ
Input Capacitance	C _{iss}	V _{DS} =10V, f=1MHz		400		pF
Output Capacitance	C _{oss}	V _{DS} =10V, f=1MHz		92		pF
Reverse Transfer Capacitance	C _{rss}	V _{DS} =10V, f=1MHz		85		pF

Marking : CK

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VEC2408

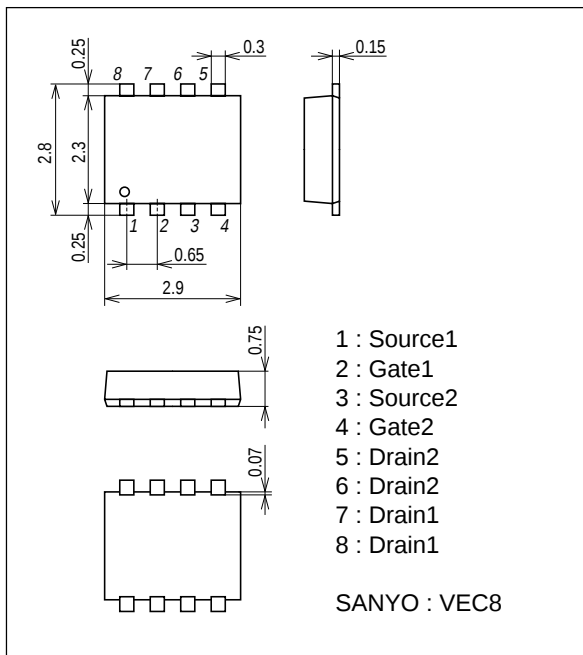
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Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Turn-ON Delay Time	$t_{d(on)}$	See specified Test Circuit.		11		ns
Rise Time	t_r	See specified Test Circuit.		58		ns
Turn-OFF Delay Time	$t_{d(off)}$	See specified Test Circuit.		58		ns
Fall Time	t_f	See specified Test Circuit.		58		ns
Total Gate Charge	Q_g	$V_{DS}=10V, V_{GS}=4V, I_D=3.5A$		6		nC
Gate-to-Source Charge	Q_{gs}	$V_{DS}=10V, V_{GS}=4V, I_D=3.5A$		0.8		nC
Gate-to-Drain "Miller" Charge	Q_{gd}	$V_{DS}=10V, V_{GS}=4V, I_D=3.5A$		2.2		nC
Diode Forward Voltage	V_{SD}	$I_S=3.5A, V_{GS}=0V$		0.85	1.2	V

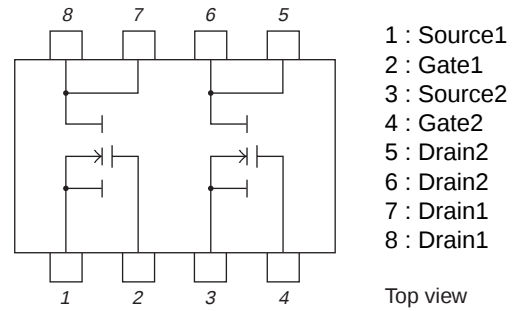
Package Dimensions

unit : mm (typ)

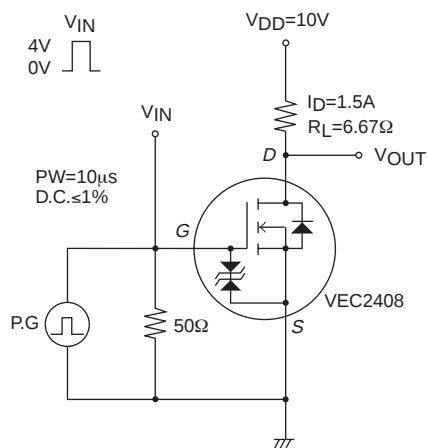
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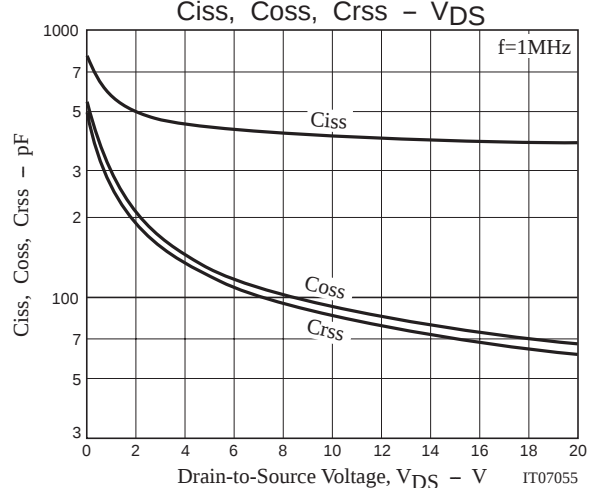
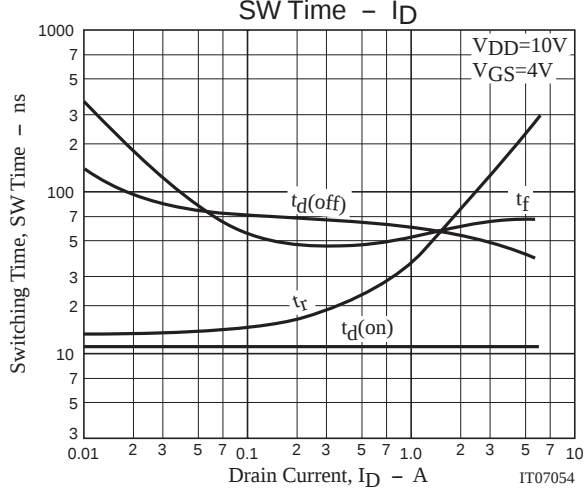
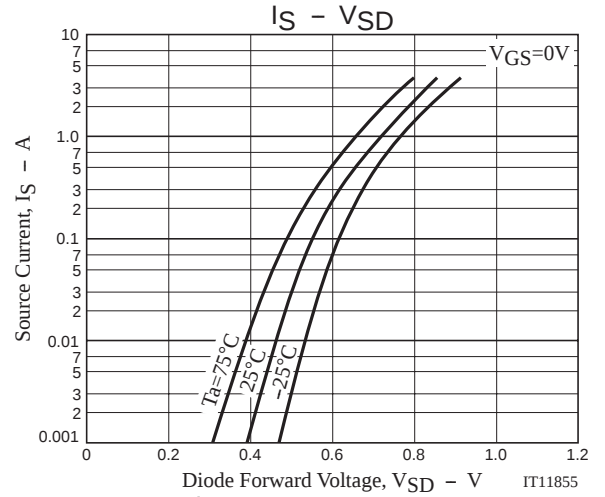
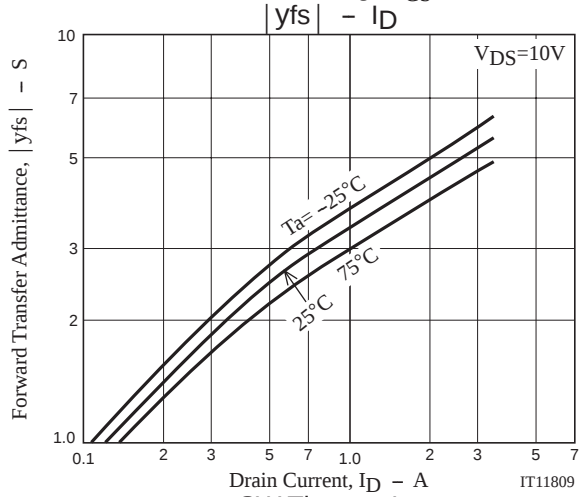
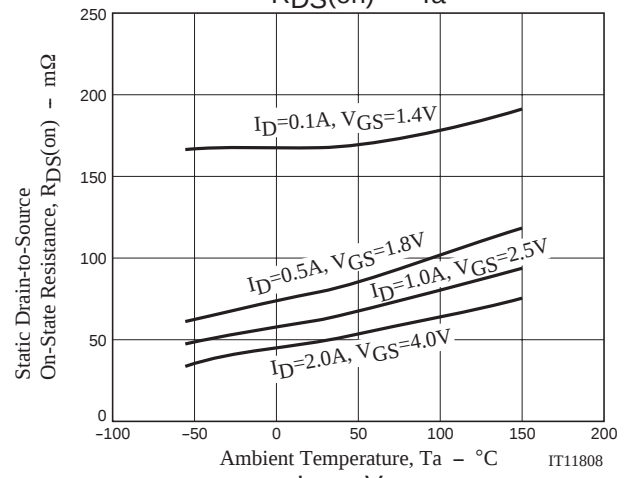
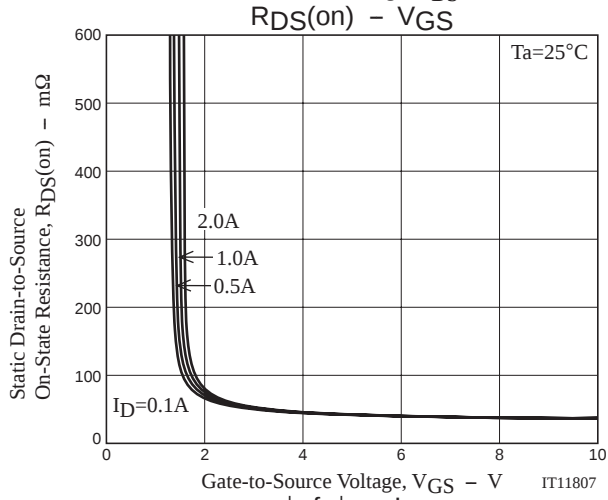
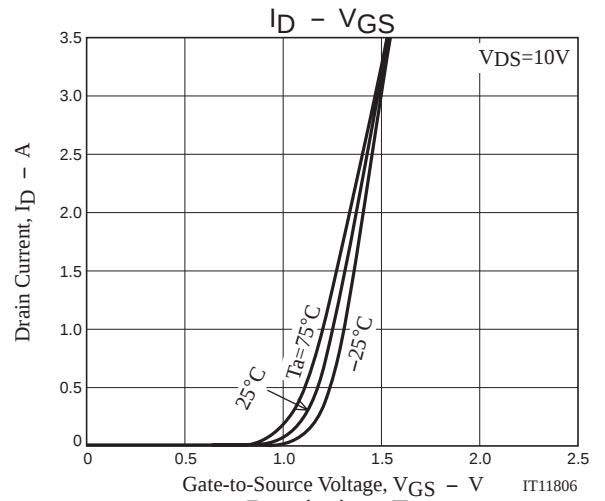
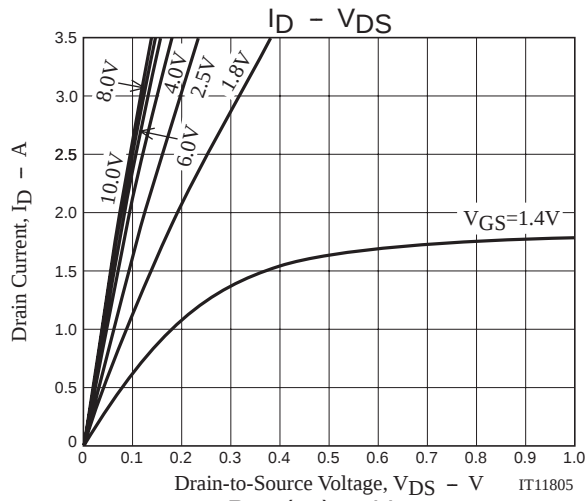


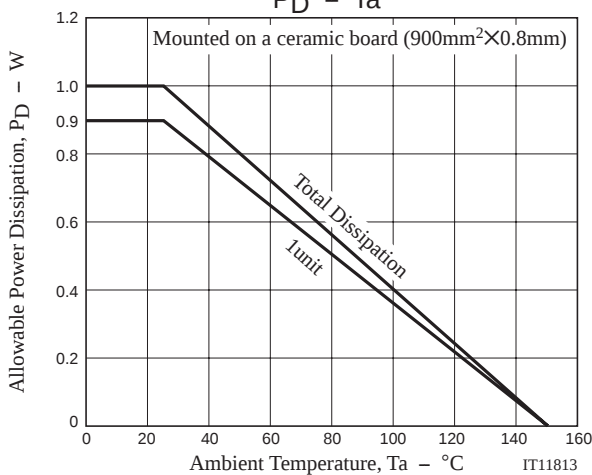
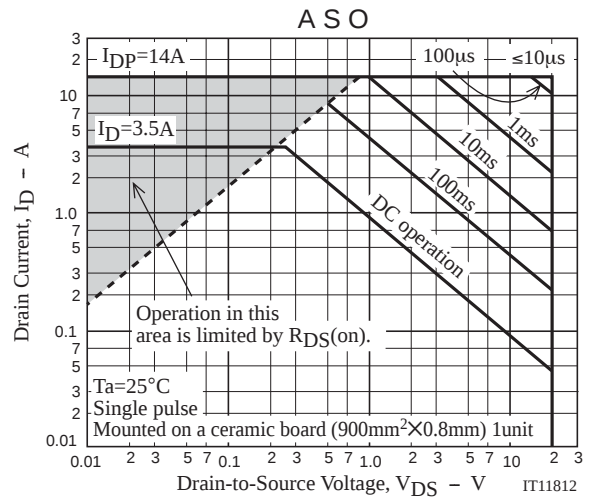
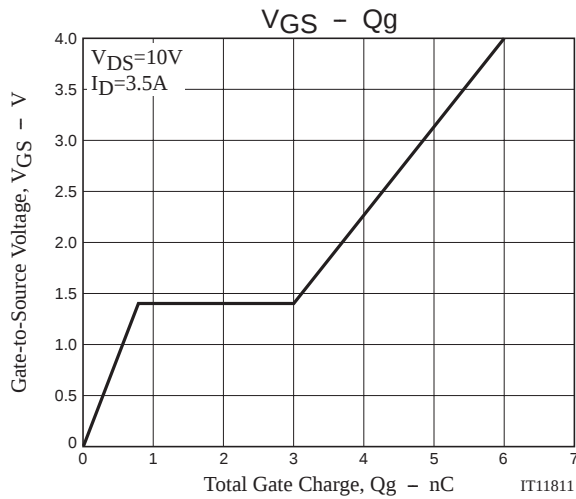
Electrical Connection



Switching Time Test Circuit







Note on usage : Since the VEC2408 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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